SPEC. NO.: PS-516	S25-XXXXX-XXXX I	REVISION: B					
PRODUCT NAME:	0.5MM PITCH EASY OI	N FPC CONN.					
	SMT R/A BOTTOM CONTACT TYPE						
PRODUCT NO:	51625 /51656/ <mark>51647</mark> SERIES	S;					
PREPARED:	CHECKED:	APPROVED:					
DATE: 2019/04/25	DATE: 2019/04/25	DATE: 2019/04/25					

Aces P/N: 51625/51656/51647 series TITLE: 0.5MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE RELEASE DATE: 2019/04/25 REVISION: B ECN No: ECN-1904411 PAGE: 2 OF 10 1 SCOPE.......4 2 3 4 REQUIREMENTS4 5 PERFORMANCE 5 6 INFRARED REFLOW CONDITION...... 8 PRODUCT QUALIFICATION AND TEST SEQUENCE.......9 INSTRUCTION UPON USAGE10

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TITLE: 0.5MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE

RELEASE DATE: 2019/04/25 REVISION: B ECN No: ECN-1904411 PAGE: **3** OF **10**

1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date
1	ECN-1311128	FOR APD1020263 (51625 SERIES)	SKY	2011/11/25
0	ECN-1410140	FOR APD1030150 增加 51656 SERIES	XUBIN	2014/10/15
Α	ECN-1606175	ADD without lock FPC/FFC retention force	LI JIN	2016/06/14
В	ECN-1904411	ADD 51647 SERIES	XUBIN	2019/04/25

TITLE: 0.5MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE

RELEASE DATE: 2019/04/25 REVISION: B ECN No: ECN-1904411 PAGE: **4** OF **10**

2 SCOPE

This specification covers performance, tests and quality requirements for 0.5MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)

Finish: (a) Contact Area: Refer to the drawing.

- (b) Under plate: Refer to the drawing.
- (c) Solder area: Refer to the drawing.
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Actuator: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.4 Fitting Nail: Copper Alloy, Finish: Refer to the drawing.
- 4.3 Ratings
 - 4.3.1 Voltage: Working Voltage Less than 36 Volts (per pin)
 - 4.3.2 50 Volts AC (per pin)
 - 4.3.3 Current: 0.5 Amperes (per pin)
 - 4.3.4 Operating Temperature : -40 $^{\circ}$ C to +85 $^{\circ}$ C

Aces P/N:	51625/	51656/5 1	1647	series
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TITLE: 0.5MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE

RELEASE DATE: 2019/04/25 REVISION: B ECN No: ECN-1904411 PAGE: **5** OF **10**

5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
	ELECTRICAL	
Item	Requirement	Standard
Low Level Contact Resistance	100 m Ω Max. (initial)per contact 40 m Ω Max. Change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	500 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 2 mA max.	250 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70, METHOD1,CONDITION1)
Insertion Loss	1dB Max.Up to 1.25 GHz Reefer to High Frequency Graphic Figure I	A common test fixture for connector Characterization shall be used.This Is differential insertion loss Requirement.
Retum Loss	12bB Max.Up to 1.3GHz Reefer to High Frequency Graphic Figure II	A common test fixture for connector Characterization shall be used. This Is differential insertion loss Requirement
Next Cross-Talk	32bB Max.Up to1.3 Ghz Reefer to High Frequency Graphic Figure III	A common test fixture for connector Characterization shall be used This Is differential cross-talk requirement.

TITLE: 0.5MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE

RELEASE DATE: 2019/04/25 REVISION: B ECN No: ECN-1904411 PAGE: **6** OF **10**

ECHANICAL							
Item	Requirement	Standard					
Durability	20 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)					
Without lock FPC Retention Force	30gf/pin Min.	A connector shall be soldered on a board and insert the actuator, pull the FPC at the speed rate of 25.4 ± 3 mm/min.					
Terminal /Housing Retention Force	0.10kgf MIN.	Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.					
Fitting Nail /Housing Retention Force	0.20kgf MIN.	Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.					
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)					
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)					

TITLE: 0.5MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE

RELEASE DATE: 2019/04/25 REVISION: B ECN No: ECN-1904411 PAGE: **7** OF **10**

ENVIRONMENTAL									
Item	Requirement	Standard							
Resistance to Reflow	See Product Qualification and Test	Pre Heat: 150°C~180°C,							
Soldering Heat	Sequence Group 10 (Lead Free)	60~120sec.							
		Heat: 230°C Min., 40sec Min.							
		Peak Temp. : 260°C Max,							
		10sec Max.							
		Mate module and subject to follow							
		condition for 5 cycles.							
Thermal Shock	See Product Qualification and Test								
	Sequence Group 4	-55 +0/-3 °C, 30 minutes							
		+85 +3/-0 °C, 30 minutes							
		(EIA-364-32, test condition I) Mated Connector							
	See Product Qualification and Test								
Humidity		96 hours.							
	Gequence Group 4	(EIA-364-31,Condition A, Method II)							
		Subject mated connectors to							
	One Dundred Overlift attended Test	temperature life at 85°C for 96							
Temperature life	See Product Qualification and Test	hours.							
	Sequence Group 5	(EIA-364-17, Test condition A)							
		Subject mated/unmated							
Calt Care	Coo Droduct Qualification and Toot	connectors to 5% salt-solution							
Salt Spray (Only For Gold Plating)	See Product Qualification and Test								
(Only For Gold Flating)	Sequence Group 6	(I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours.							
		(EIA-364-26)							
	Tin plating:	(=:: 55: 25)							
		And then into solder bath,							
Soldor ability	minimum of 95% solder coverage.	Temperature at 245 ±5°€, for 4-5							
Solder ability	Gold plating:	sec.							
	Solder able area shall have	(EIA-364-52)							
	minimum of 75% solder coverage								
Hand Soldering	Appearance: No damage	T≧350°C, 3sec at least.							
Temperature Resistance	<u> </u>	, in the second							

Note. Flowing Mixed Gas shell be conduct by customer request.

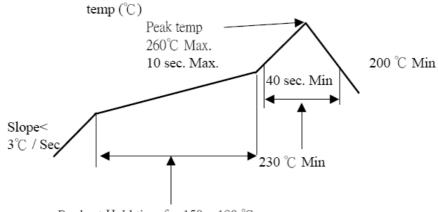
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TITLE: 0.5MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE

RELEASE DATE: 2019/04/25 REVISION: B ECN No: ECN-1904411 PAGE: **8** OF **10**

6 INFRARED REFLOW CONDITION

TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)



Pre-heat Hold time for $150 \sim 180$ °C is $60 \sim 120$ sec.

TITLE: 0.5MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE

RELEASE DATE: 2019/04/25 REVISION: B ECN No: ECN-1904411 PAGE: **9** OF **10**

7 PRODUCT QUALIFICATION AND TEST SEQUENCE

					Tes	st Gro	up				
Test or Examination	1	2	3	4	5	6	7	8	9	10	11
					Test	Sequ	ence				
Examination of Product			1、7	1、6	1 \ 4			1	1	1 . 8	
Low Level Contact Resistance		1 \ 4	2、10	2 \ 9	2 \ 5			3		2 \ 11	
Insulation Resistance			3 · 9	3、8						3、10	
Dielectric Withstanding Voltage			4 \ 8	4 \ 7						4 . 9	
Temperature rise	1										
Vibration		2									
Shock (Mechanical)		3									
Thermal Shock			5								
Humidity			6								
Temperature life				5							
Salt Spray(Only For Gold Plating)					3						
Solder ability						1					
Terminal / Housing Retention Force							1				
Fitting Nail /Housing Retention Force							2				
Resistance to Soldering Heat								2			
Hand Soldering Temperature Resistance									2		
Durability										6	
FPC Retention Force										5 \ 7	
Sample Size	2	4	4	4	4	2	4	4	4		

TITLE: 0.5MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE

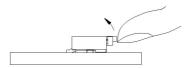
RELEASE DATE: 2019/04/25 REVISION: B ECN No: ECN-1904411 PAGE: **10** OF **10**

8 INSTRUCTION UPON USAGE

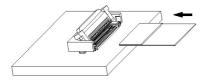
Operation

FPC/FFC Termination procedure. Connector installed on the board.

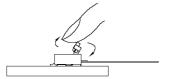
1) Lift up the actuator. Use thumb or index finger.



2) Do with the actuator opened completely, and insert it in the interior of the insertion entrance surely when you insert FPC/FFC. There are some insertion resistance because this connector has the FPC/FFC temporary retention mechanism.

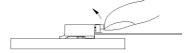


3) Rotate down the actuator until firmly closed. It is critical that the inserted FPC/FFC is not moved and remains fully inserted. Should the FPC/FFC be moved, open the actuator and repeat the process, starting with Step 1 above.



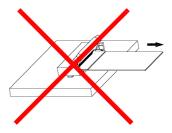
FPC/FFC Removal

- 1) Lift up the actuator.
- 2) Carefully remove the FPC/FFC.



Precautions

Do when yon pull out mating FPC/FFC with the Actuator opened completely. Confirm whether to Have adhered to the terminal contact part before FPC/FFC is mated with the connector housing when the opening of the actuator is the un-complete and FPC/FFC is pulled out.



2) Do not add the load mating FPC/FFC with connector housing.



 Due to the structure of the connectors, they do not have string resistance to upward pulling; therefore, support the FPC/FFC when a pulling force is applied to it.

